

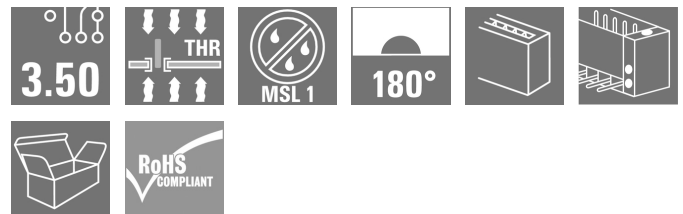
SL-SMT 3.50/16/180F 3.2SN BK BX**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Product image

High-temperature-resistant male header, 3.50 mm pitch.

- **Plugging direction parallel (90°), straight 180° or angled (135°) to PCB**
- **Housing variants: closed side (G), screw flange (F), solder flange (LF) or snap-on solder flange (RF)**
- **Optimised for the SMT process**
- **Pin length 3.2 mm universal for all soldering methods**
- **Pin length 1.5 mm optimised for reflow soldering methods**
- **Packed either in a box (BX) or tape-on-reel (RL)**
- **Male header can be coded**

General ordering data

Version	PCB plug-in connector, male header, Flange, THT/THR solder connection, 3.50 mm, Number of poles: 16, 180°, Solder pin length (l): 3.2 mm, tinned, black, Box
Order No.	1842910000
Type	SL-SMT 3.50/16/180F 3.2SN BK BX
GTIN (EAN)	4032248354375
Qty.	24 pc(s).
Product data	IEC: 320 V / 15 A UL: 300 V / 10 A
Packaging	Box

SL-SMT 3.50/16/180F 3.2SN BK BX

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Technical data

Dimensions and weights

Depth	7.5 mm	Depth (inches)	0.295 inch
Height	12.6 mm	Height (inches)	0.496 inch
Width	63 mm	Width (inches)	2.48 inch
Net weight	5.48 g		

System specifications

Product family	OMNIMATE Signal - series BL/SL 3.50		
Type of connection	Board connection		
Mounting onto the PCB	THT/THR solder connection		
Pitch in mm (P)	3.5 mm		
Pitch in inches (P)	0.138 "		
Outgoing elbow	180°		
Number of poles	16		
Number of solder pins per pole	1		
Solder pin length (l)	3.2 mm		
Solder pin length tolerance	0 / -0.3 mm		
Solder pin dimensions	d = 1.2 mm, Octagonal		
Solder pin dimensions = d tolerance	0 / -0.03 mm		
Solder eyelet hole diameter (D)	1.4 mm		
Solder eyelet hole diameter tolerance (D)	+ 0.1 mm		
Outside diameter of solder pad	2.3 mm		
Template aperture diameter	2.1 mm		
L1 in mm	52.5 mm		
L1 in inches	2.067 "		
Number of rows	1		
Pin series quantity	1		
Touch-safe protection acc. to DIN VDE 57 106	finger-safe plugged/ back-of-hand-safe unplugged		
Touch-safe protection acc. to DIN VDE 0470	IP20 plugged/ IP10 unplugged		
Protection degree	IP10		
Volume resistance	≤5 mΩ		
Can be coded	Yes		
Plugging cycles	25		
Plugging force/pole, max.	6 N		
Pulling force/pole, max.	6 N		
Tightening torque	Torque type	Mounting screw, PCB	
	Usage information	Tightening torque	min. 0.1 Nm
			max. 0.15 Nm
		Recommended screw	Part number PTSC KA 2.2X4.5 WN1412

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Cu-alloy
Contact surface	tinned	Layer structure of solder connection	2...3 µm Ni / 5...7 µm Sn
Layer structure of plug contact	2...3 µm Ni / 5...7 µm Sn	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	100 °C		

Creation date June 13, 2025 5:30:55 AM CEST

Catalogue status 07.06.2025 / We reserve the right to make technical changes.

SL-SMT 3.50/16/180F 3.2SN BK BX

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Technical data

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	15 A
Rated current, max. number of poles (Tu=20°C)	12 A	Rated current, min. number of poles (Tu=40°C)	13 A
Rated current, max. number of poles (Tu=40°C)	10 A	Rated voltage for surge voltage class / pollution degree II/2	320 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	160 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	2.5 kV	Short-time withstand current resistance	3 x 1s with 100 A

Rated data acc. to CSA

Institute (CSA)		Certificate No. (CSA)	200039-1176845
Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	10 A	Rated current (Use group D / CSA)	10 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Rated data acc. to UL 1059

Institute (UR)		Certificate No. (UR)	E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group B / UL 1059)	10 A	Rated current (Use group D / UL 1059)	10 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Packing

Packaging	Box	VPE length	340 mm
VPE width	134 mm	VPE height	22 mm

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ETIM 9.0	EC002637
ETIM 10.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
ECLASS 11.0	27-46-02-01	ECLASS 12.0	27-46-02-01
ECLASS 13.0	27-46-02-01	ECLASS 14.0	27-46-02-01
ECLASS 15.0	27-46-02-01		

Environmental Product Compliance

RoHS Compliance Status	Compliant without exemption
REACH SVHC	No SVHC above 0.1 wt%

Creation date June 13, 2025 5:30:55 AM CEST

Catalogue status 07.06.2025 / We reserve the right to make technical changes.

SL-SMT 3.50/16/180F 3.2SN BK BX**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com**Technical data****Important note**

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	• Gold-plated contact surfaces on request • Rated current related to rated cross-section & min. No. of poles. • Diameter of solder eyelet $D = 1.4 + 0.1 \text{ mm}$ • Solder eyelet diameter $D = 1.5 + 0.1 \text{ mm}$, from 9 poles • P on drawing = pitch • Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. • For additional mechanical support for male connectors with screw flange (...F), we recommend an additional cable gland with fastening screws (sheet metal screw ISO 1481-ST 2.2x4.5 C or ISO 7049-ST 2.2x4.5 C – see Accessories). Cable gland only permitted before soldering. • In accordance with IEC 61984, OMNIMATE-connectors are connectors without breaking capacity (COC). During designated use, connectors are not allowed to be engaged or disengaged when live or under load • Long term storage of the product with average temperature of 50 °C and maximum humidity 70%, 36 months

Approvals

Approvals



Approvals MAMID	https://mdcop.weidmueller.com/mediadelivery/rendition/900_319226/-T1z1mm-S800/ https://mdcop.weidmueller.com/mediadelivery/rendition/900_319262/-T1z1mm-S800/
ROHS	Conform
UL File Number Search	UL Website
Certificate No. (UR)	E60693

SL-SMT 3.50/16/180F 3.2SN BK BX**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com**Technical data****Downloads**Approval/Certificate/Document of Con-
formity[Declaration of the Manufacturer](#)

Engineering Data

[CAD data – STEP](#)

Product Change Notification

[PCN_2015_208_PL30X_SC-SMT_SL_SMT_3.xx_5.xx_neue_Tapeverpackung_Step_4_DE](#)[PCN_2015_208_PL30X_SC-SMT_SL_SMT_3.xx_5.xx_new_Tape_Packaging_Step_4_EN](#)

Catalogues

[Catalogues in PDF-format](#)

Brochures

[FL DRIVES EN](#)[MB SMT EN](#)[FL DRIVES DE](#)[MB DEVICE MANUF. EN](#)[FL BUILDING SAFETY EN](#)[FL APPL LED LIGHTING EN](#)[FL INDUSTR.CONTROLS EN](#)[FL MACHINE SAFETY EN](#)[FL HEATING ELECTR EN](#)[FL APPL INVERTER EN](#)[FL_BASE_STATION_EN](#)[FL ELEVATOR EN](#)[FL POWER SUPPLY EN](#)[FL 72H SAMPLE SER EN](#)[PO OMNIMATE EN](#)[PO OMNIMATE EN](#)

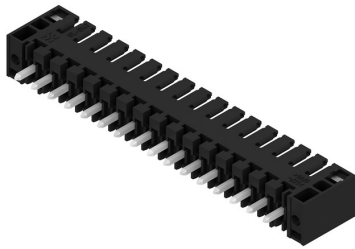
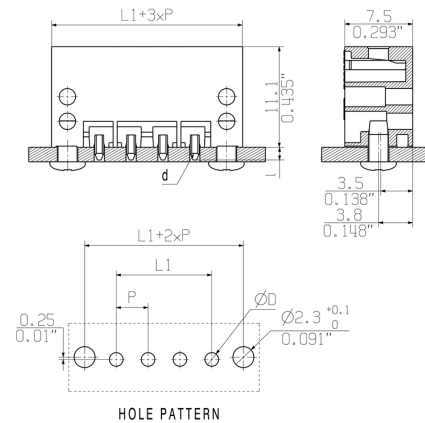
White paper surface mount technology

[Download Whitepaper](#)

SL-SMT 3.50/16/180F 3.2SN BK BX

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 26
D-32758 Detmold
Germany

www.weidmueller.com

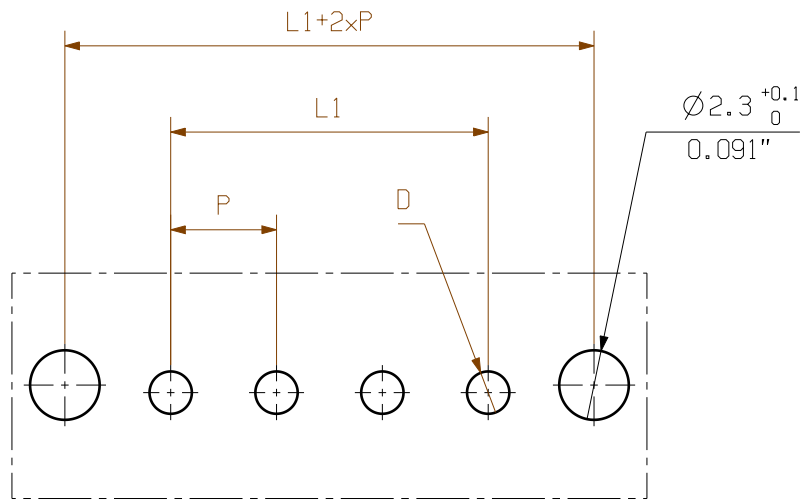
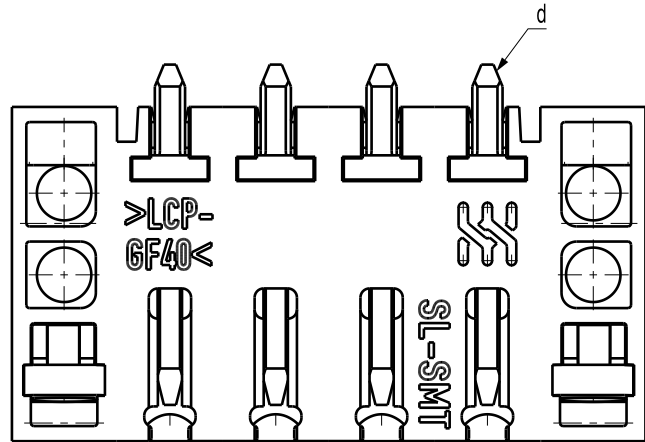
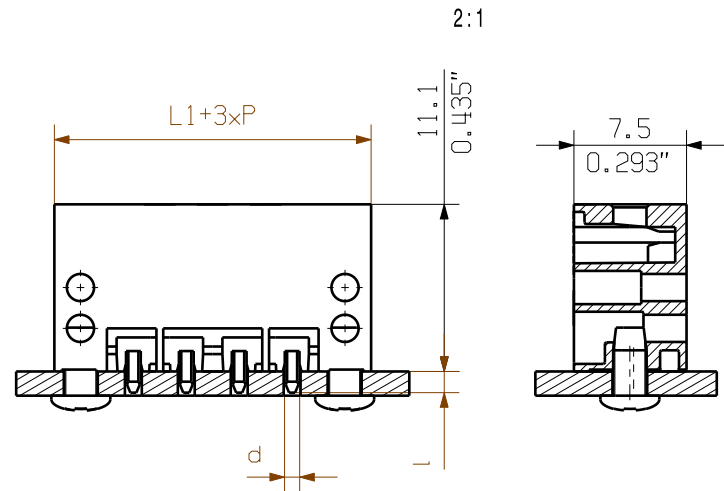
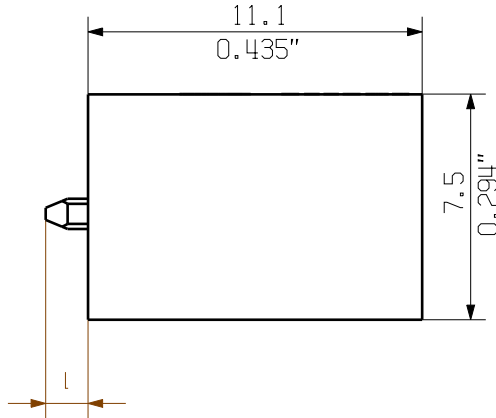
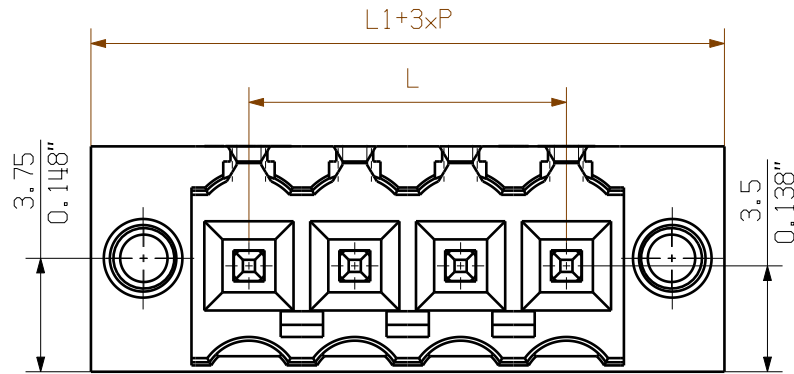
Drawings**Product image****Dimensional drawing**

The reproduction, distribution and utilization of this document as well as the communication of its contents to others without explicit authorization is prohibited. Offenders will be held liable for the payment of damages. Weidmüller exclusively reserves the right to file for patents, utility models or designs.

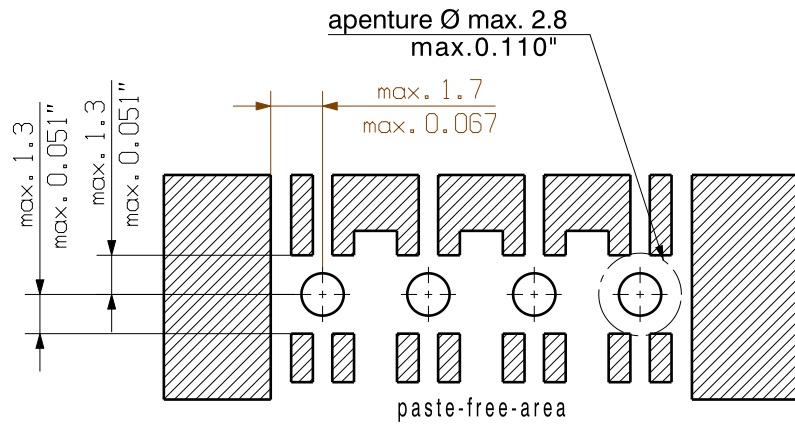
© Weidmüller Interface GmbH & Co. KG

A
B
C
D
E
F

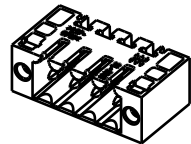
A
B
C
D
E
F



HOLE PATTERN



shown: SL-SMT 3.5 04 180F
1:1



pin length l	tolerance
1,5	0,0 -0,3
2,6	0,0 -0,3
3,2	0,0 -0,3
4,5	0,0 -0,3

24	80,50	3,169	+/- 0.2
23	77,00	3,031	
22	73,50	2,894	
21	70,00	2,756	
20	66,50	2,618	+/- 0.15
19	63,00	2,480	
18	59,50	2,343	
17	56,00	2,205	
16	52,50	2,067	+/- 0.1
15	49,00	1,929	
14	45,50	1,791	
13	42,00	1,654	
12	38,50	1,516	+/- 0.1
11	35,00	1,378	
10	31,50	1,240	
9	28,00	1,102	
8	24,50	0,965	+/- 0.1
7	21,00	0,827	
6	17,50	0,689	
5	14,00	0,551	
4	10,50	0,413	+/- 0.1
3	7,00	0,276	
2	3,50	0,138	
n	L1 [mm]	L1 [Inch]	tolerance

For the mounting of PCBs, it should be noted that the rated data given in the catalogue relates only to the connection elements. The necessary creepage and clearance paths must be observed in connection with the respective applicant in accordance with VDE 0110. The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller connectors are tested to the DIN VDE 0627 standard, and are valid for its field of application. Provided that the connectors are used to the intended purpose, all requirements with respect to the occurring of electrical, mechanical, thermic and corrosive stress will be satisfied.

shown: SL-SMT 3.50/04/180F



General Tolerances: ☐ WN700144-W.. ☐ WN 212010 ☒ ISO 2768:1989-mk Tolerances ISO 8015	
Changes: EC00010819	
Mat. No. (SAP) 1753002001	
Drawings Assembly	
Drawn Helis, Maria	
Responsible Amann, Alexander	
Approved Lang, Thomas	
11.03.2024	
Weidmüller	
SL-SMT 3.50/./180... MALE HEADER STIFTLEISTE	
34146 Drawing no. 13 Scale: 4:1 Sheet 4 / 6	

Recommended wave soldering profiles

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com



Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.